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## Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

## **Applications of Embedded - FPGAs**

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

### Details

Product Status	Obsolete
Number of LABs/CLBs	-
Number of Logic Elements/Cells	15000
Total RAM Bits	331776
Number of I/O	300
Number of Gates	-
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	484-BBGA
Supplier Device Package	484-FPBGA (23x23)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lfxp15e-5fn484c">https://www.e-xfl.com/product-detail/lattice-semiconductor/lfxp15e-5fn484c</a>

### Features

- **Non-volatile, Infinitely Reconfigurable**
  - Instant-on – powers up in microseconds
  - No external configuration memory
  - Excellent design security, no bit stream to intercept
  - Reconfigure SRAM based logic in milliseconds
  - SRAM and non-volatile memory programmable through system configuration and JTAG ports
- **Sleep Mode**
  - Allows up to 1000x static current reduction
- **TransFR™ Reconfiguration (TFR)**
  - In-field logic update while system operates
- **Extensive Density and Package Options**
  - 3.1K to 19.7K LUT4s
  - 62 to 340 I/Os
  - Density migration supported
- **Embedded and Distributed Memory**
  - 54 Kbits to 396 Kbits sysMEM™ Embedded Block RAM
  - Up to 79 Kbits distributed RAM
  - Flexible memory resources:
    - Distributed and block memory

### ■ Flexible I/O Buffer

- Programmable sysIO™ buffer supports wide range of interfaces:
  - LVCMS 3.3/2.5/1.8/1.5/1.2
  - LVTTL
  - SSTL 18 Class I
  - SSTL 3/2 Class I, II
  - HSTL15 Class I, III
  - HSTL 18 Class I, II, III
  - PCI
  - LVDS, Bus-LVDS, LVPECL, RSDS

### ■ Dedicated DDR Memory Support

- Implements interface up to DDR333 (166MHz)

### ■ sysCLOCK™ PLLs

- Up to 4 analog PLLs per device
- Clock multiply, divide and phase shifting

### ■ System Level Support

- IEEE Standard 1149.1 Boundary Scan, plus ispTRACY™ internal logic analyzer capability
- Onboard oscillator for configuration
- Devices operate with 3.3V, 2.5V, 1.8V or 1.2V power supply

**Table 1-1. LatticeXP Family Selection Guide**

Device	LFXP3	LFXP6	LFXP10	LFXP15	LFXP20
PFU/PFF Rows	16	24	32	40	44
PFU/PFF Columns	24	30	38	48	56
PFU/PFF (Total)	384	720	1216	1932	2464
LUTs (K)	3	6	10	15	20
Distributed RAM (KBits)	12	23	39	61	79
EBR SRAM (KBits)	54	72	216	324	396
EBR SRAM Blocks	6	8	24	36	44
V <sub>CC</sub> Voltage	1.2/1.8/2.5/3.3V	1.2/1.8/2.5/3.3V	1.2/1.8/2.5/3.3V	1.2/1.8/2.5/3.3V	1.2/1.8/2.5/3.3V
PLLs	2	2	4	4	4
Max. I/O	136	188	244	300	340
<b>Packages and I/O Combinations:</b>					
100-pin TQFP (14 x 14 mm)	62				
144-pin TQFP (20 x 20 mm)	100	100			
208-pin PQFP (28 x 28 mm)	136	142			
256-ball fpBGA (17 x 17 mm)		188	188	188	188
388-ball fpBGA (23 x 23 mm)			244	268	268
484-ball fpBGA (23 x 23 mm)				300	340

### Architecture Overview

The LatticeXP architecture contains an array of logic blocks surrounded by Programmable I/O Cells (PIC). Interspersed between the rows of logic blocks are rows of sysMEM Embedded Block RAM (EBR) as shown in Figure 2-1.

On the left and right sides of the PFU array, there are Non-volatile Memory Blocks. In configuration mode this non-volatile memory is programmed via the IEEE 1149.1 TAP port or the sysCONFIG™ peripheral port. On power up, the configuration data is transferred from the Non-volatile Memory Blocks to the configuration SRAM. With this technology, expensive external configuration memories are not required and designs are secured from unauthorized read-back. This transfer of data from non-volatile memory to configuration SRAM via wide busses happens in microseconds, providing an “instant-on” capability that allows easy interfacing in many applications.

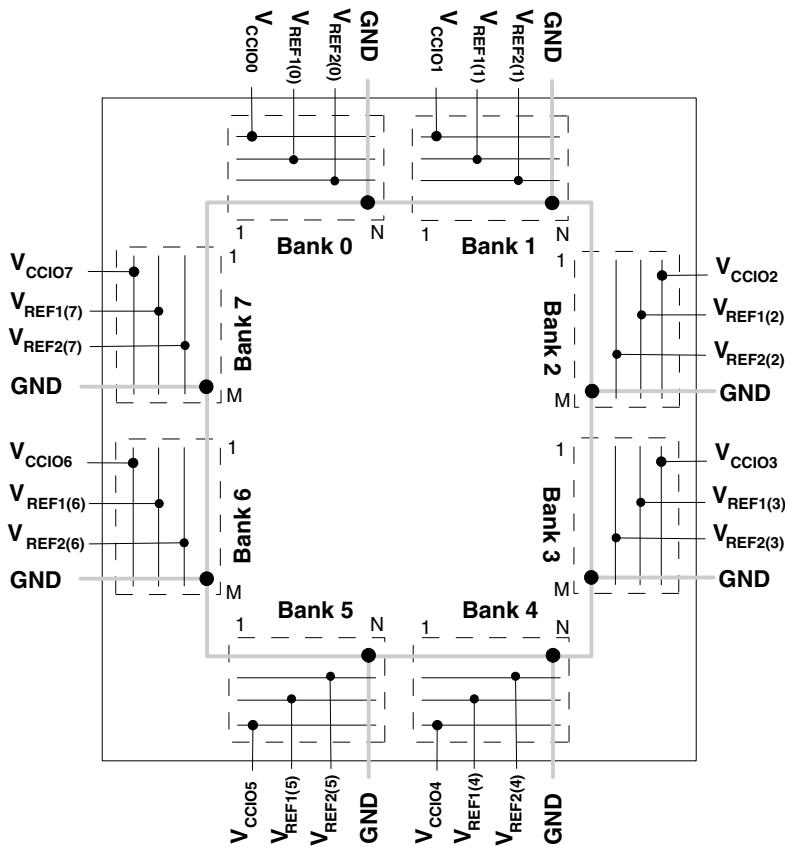
There are two kinds of logic blocks, the Programmable Functional Unit (PFU) and Programmable Functional unit without RAM/ROM (PFF). The PFU contains the building blocks for logic, arithmetic, RAM, ROM and register functions. The PFF block contains building blocks for logic, arithmetic and ROM functions. Both PFU and PFF blocks are optimized for flexibility, allowing complex designs to be implemented quickly and efficiently. Logic Blocks are arranged in a two-dimensional array. Only one type of block is used per row. The PFU blocks are used on the outside rows. The rest of the core consists of rows of PFF blocks interspersed with rows of PFU blocks. For every three rows of PFF blocks there is a row of PFU blocks.

Each PIC block encompasses two PIOs (PIO pairs) with their respective sysIO interfaces. PIO pairs on the left and right edges of the device can be configured as LVDS transmit/receive pairs. sysMEM EBRs are large dedicated fast memory blocks. They can be configured as RAM or ROM.

The PFU, PFF, PIC and EBR Blocks are arranged in a two-dimensional grid with rows and columns as shown in Figure 2-1. The blocks are connected with many vertical and horizontal routing channel resources. The place and route software tool automatically allocates these routing resources.

At the end of the rows containing the sysMEM Blocks are the sysCLOCK Phase Locked Loop (PLL) Blocks. These PLLs have multiply, divide and phase shifting capability; they are used to manage the phase relationship of the clocks. The LatticeXP architecture provides up to four PLLs per device.

Every device in the family has a JTAG Port with internal Logic Analyzer (ispTRACY) capability. The sysCONFIG port which allows for serial or parallel device configuration. The LatticeXP devices are available for operation from 3.3V, 2.5V, 1.8V and 1.2V power supplies, providing easy integration into the overall system.

**Figure 2-28. LatticeXP Banks**

Note: N and M are the maximum number of I/Os per bank.

LatticeXP devices contain two types of sysIO buffer pairs.

#### 1. Top and Bottom sysIO Buffer Pair (Single-Ended Outputs Only)

The sysIO buffer pairs in the top and bottom banks of the device consist of two single-ended output drivers and two sets of single-ended input buffers (both ratioed and referenced). The referenced input buffer can also be configured as a differential input.

The two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential input buffer and the comp (complementary) pad is associated with the negative side of the differential input buffer.

Only the I/Os on the top and bottom banks have PCI clamps. Note that the PCI clamp is enabled after  $V_{CC}$ ,  $V_{CCAUX}$  and  $V_{CCIO}$  are at valid operating levels and the device has been configured.

#### 2. Left and Right sysIO Buffer Pair (Differential and Single-Ended Outputs)

The sysIO buffer pairs in the left and right banks of the device consist of two single-ended output drivers, two sets of single-ended input buffers (both ratioed and referenced) and one differential output driver. The referenced input buffer can also be configured as a differential input. In these banks the two pads in the pair are described as “true” and “comp”, where the true pad is associated with the positive side of the differential I/O, and the comp (complementary) pad is associated with the negative side of the differential I/O.

Select I/Os in the left and right banks have LVDS differential output drivers. Refer to the Logic Signal Connections tables for more information.

November 2007

Data Sheet DS1001

### Absolute Maximum Ratings<sup>1, 2, 3, 4</sup>

	XPE (1.2V)	XPC (1.8V/2.5V/3.3V)
Supply Voltage V <sub>CC</sub> . . . . .	-0.5 to 1.32V . . . . .	-0.5 to 3.75V . . . . .
Supply Voltage V <sub>CCP</sub> . . . . .	-0.5 to 1.32V . . . . .	-0.5 to 3.75V . . . . .
Supply Voltage V <sub>CCAUX</sub> . . . . .	-0.5 to 3.75V . . . . .	-0.5 to 3.75V . . . . .
Supply Voltage V <sub>CCJ</sub> . . . . .	-0.5 to 3.75V . . . . .	-0.5 to 3.75V . . . . .
Output Supply Voltage V <sub>CCIO</sub> . . . . .	-0.5 to 3.75V . . . . .	-0.5 to 3.75V . . . . .
I/O Tristate Voltage Applied <sup>5</sup> . . . . .	-0.5 to 3.75V . . . . .	-0.5 to 3.75V . . . . .
Dedicated Input Voltage Applied <sup>5</sup> . . . . .	-0.5 to 3.75V . . . . .	-0.5 to 4.25V . . . . .
Storage Temperature (Ambient) . . . . .	-65 to 150°C . . . . .	-65 to 150°C . . . . .
Junction Temp. (T <sub>j</sub> ) . . . . .	+125°C . . . . .	+125°C . . . . .

1. Stress above those listed under the "Absolute Maximum Ratings" may cause permanent damage to the device. Functional operation of the device at these or any other conditions outside of those indicated in the operational sections of this specification is not implied.

2. Compliance with the Lattice *Thermal Management* document is required.

3. All voltages referenced to GND.

4. All chip grounds are connected together to a common package GND plane.

5. Overshoot and undershoot of -2V to (V<sub>IHMAX</sub> + 2) volts is permitted for a duration of <20ns.

### Recommended Operating Conditions<sup>3</sup>

Symbol	Parameter	Min.	Max.	Units
V <sub>CC</sub>	Core Supply Voltage for 1.2V Devices	1.14	1.26	V
	Core Supply Voltage for 1.8V/2.5V/3.3V Devices	1.71	3.465	V
V <sub>CCP</sub>	Supply Voltage for PLL for 1.2V Devices	1.14	1.26	V
	Supply Voltage for PLL for 1.8V/2.5V/3.3V Devices	1.71	3.465	V
V <sub>CCAUX</sub> <sup>4</sup>	Auxiliary Supply Voltage	3.135	3.465	V
V <sub>CCIO</sub> <sup>1, 2</sup>	I/O Driver Supply Voltage	1.14	3.465	V
V <sub>CCJ</sub> <sup>1</sup>	Supply Voltage for IEEE 1149.1 Test Access Port	1.14	3.465	V
t <sub>JCOM</sub>	Junction Temperature, Commercial Operation	0	85	C
t <sub>JIND</sub>	Junction Temperature, Industrial Operation	-40	100	C
t <sub>JFLASHCOM</sub>	Junction Temperature, Flash Programming, Commercial	0	85	C
t <sub>JFLASHIND</sub>	Junction Temperature, Flash Programming, Industrial	0	85	C

1. If V<sub>CCIO</sub> or V<sub>CCJ</sub> is set to 3.3V, they must be connected to the same power supply as V<sub>CCAUX</sub>. For the XPE devices (1.2V V<sub>CC</sub>), if V<sub>CCIO</sub> or V<sub>CCJ</sub> is set to 1.2V, they must be connected to the same power supply as V<sub>CC</sub>.

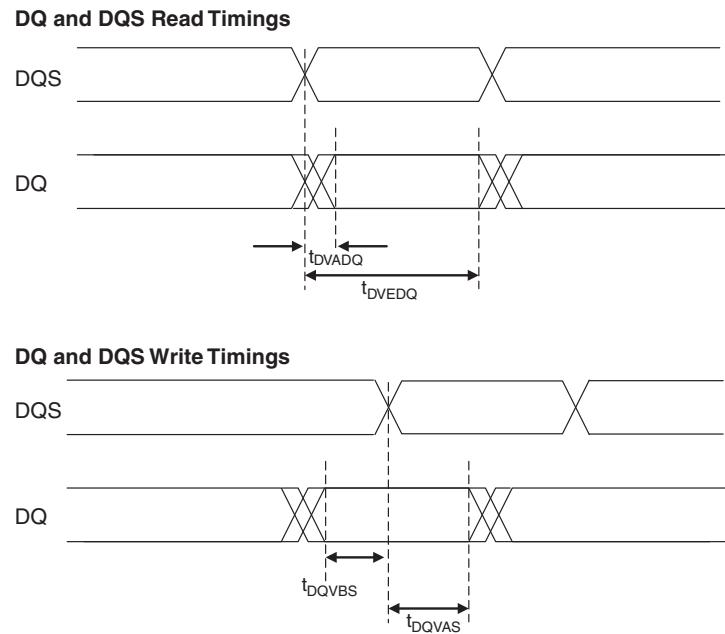
2. See recommended voltages by I/O standard in subsequent table.

3. The system designer must ensure that the FPGA design stays within the specified junction temperature and package thermal capabilities of the device based on the expected operating frequency, activity factor and environment conditions of the system.

4. V<sub>CCAUX</sub> ramp rate must not exceed 30mV/μs during power up when transitioning between 0V and 3.3V.

**sysIO Differential Electrical Characteristics****LVDS****Over Recommended Operating Conditions**

<b>Parameter Symbol</b>	<b>Parameter Description</b>	<b>Test Conditions</b>	<b>Min.</b>	<b>Typ.</b>	<b>Max.</b>	<b>Units</b>
$V_{INP}, V_{INM}$	Input Voltage		0	—	2.4	V
$V_{THD}$	Differential Input Threshold		+/-100	—	—	mV
$V_{CM}$	Input Common Mode Voltage	$100\text{mV} \leq V_{THD}$	$V_{THD}/2$	1.2	1.8	V
		$200\text{mV} \leq V_{THD}$	$V_{THD}/2$	1.2	1.9	V
		$350\text{mV} \leq V_{THD}$	$V_{THD}/2$	1.2	2.0	V
$I_{IN}$	Input current	Power on or power off	—	—	+/-10	$\mu\text{A}$
$V_{OH}$	Output high voltage for $V_{OP}$ or $V_{OM}$	$R_T = 100$ ohms	—	1.38	1.60	V
$V_{OL}$	Output low voltage for $V_{OP}$ or $V_{OM}$	$R_T = 100$ ohms	0.9V	1.03	—	V
$V_{OD}$	Output voltage differential	$(V_{OP} - V_{OM}), R_T = 100$ ohms	250	350	450	mV
$\Delta V_{OD}$	Change in $V_{OD}$ between high and low		—	—	50	mV
$V_{OS}$	Output voltage offset	$(V_{OP} - V_{OM})/2, R_T = 100$ ohms	1.125	1.25	1.375	V
$\Delta V_{OS}$	Change in $V_{OS}$ between H and L		—	—	50	mV
$I_{OSD}$	Output short circuit current	$V_{OD} = 0\text{V}$ Driver outputs shorted	—	—	6	mA

**Figure 3-5. DDR Timings**

**LatticeXP Internal Timing Parameters<sup>1</sup>**

Over Recommended Operating Conditions

Parameter	Description	-5		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>PFU/PFF Logic Mode Timing</b>								
t <sub>LUT4_PFU</sub>	LUT4 Delay (A to D Inputs to F Output)	—	0.28	—	0.34	—	0.40	ns
t <sub>LUT6_PFU</sub>	LUT6 Delay (A to D Inputs to OFX Output)	—	0.44	—	0.53	—	0.63	ns
t <sub>LSR_PFU</sub>	Set/Reset to Output of PFU	—	0.90	—	1.08	—	1.29	ns
t <sub>SUM_PFU</sub>	Clock to Mux (M0,M1) Input Setup Time	0.13	—	0.15	—	0.19	—	ns
t <sub>HM_PFU</sub>	Clock to Mux (M0,M1) Input Hold Time	-0.04	—	-0.03	—	-0.03	—	ns
t <sub>SUD_PFU</sub>	Clock to D Input Setup Time	0.13	—	0.16	—	0.19	—	ns
t <sub>HD_PFU</sub>	Clock to D Input Hold Time	-0.03	—	-0.02	—	-0.02	—	ns
t <sub>CK2Q_PFU</sub>	Clock to Q Delay, D-type Register Configuration	—	0.40	—	0.48	—	0.58	ns
t <sub>LE2Q_PFU</sub>	Clock to Q Delay Latch Configuration	—	0.53	—	0.64	—	0.76	ns
t <sub>LD2Q_PFU</sub>	D to Q Throughput Delay when Latch is Enabled	—	0.55	—	0.66	—	0.79	ns
<b>PFU Dual Port Memory Mode Timing</b>								
t <sub>CORAM_PFU</sub>	Clock to Output	—	0.40	—	0.48	—	0.58	ns
t <sub>SUDATA_PFU</sub>	Data Setup Time	-0.18	—	-0.14	—	-0.11	—	ns
t <sub>HDATA_PFU</sub>	Data Hold Time	0.28	—	0.34	—	0.40	—	ns
t <sub>SUADDR_PFU</sub>	Address Setup Time	-0.46	—	-0.37	—	-0.30	—	ns
t <sub>HADDR_PFU</sub>	Address Hold Time	0.71	—	0.85	—	1.02	—	ns
t <sub>SUWREN_PFU</sub>	Write/Read Enable Setup Time	-0.22	—	-0.17	—	-0.14	—	ns
t <sub>HWREN_PFU</sub>	Write/Read Enable Hold Time	0.33	—	0.40	—	0.48	—	ns
<b>PIC Timing</b>								
<b>PIO Input/Output Buffer Timing</b>								
t <sub>IN_PIO</sub>	Input Buffer Delay	—	0.62	—	0.72	—	0.85	ns
t <sub>OUT_PIO</sub>	Output Buffer Delay	—	2.12	—	2.54	—	3.05	ns
<b>IOLOGIC Input/Output Timing</b>								
t <sub>SUI_PIO</sub>	Input Register Setup Time (Data Before Clock)	1.35	—	1.83	—	2.37	—	ns
t <sub>HI_PIO</sub>	Input Register Hold Time (Data After Clock)	0.05	—	0.05	—	0.05	—	ns
t <sub>COO_PIO</sub>	Output Register Clock to Output Delay	—	0.36	—	0.44	—	0.52	ns
t <sub>SUCE_PIO</sub>	Input Register Clock Enable Setup Time	-0.09	—	-0.07	—	-0.06	—	ns
t <sub>HCE_PIO</sub>	Input Register Clock Enable Hold Time	0.13	—	0.16	—	0.19	—	ns
t <sub>SULSR_PIO</sub>	Set/Reset Setup Time	0.19	—	0.23	—	0.28	—	ns
t <sub>HLSR_PIO</sub>	Set/Reset Hold Time	-0.14	—	-0.11	—	-0.09	—	ns
<b>EBR Timing</b>								
t <sub>CO_EBR</sub>	Clock to Output from Address or Data	—	4.01	—	4.81	—	5.78	ns
t <sub>COO_EBR</sub>	Clock to Output from EBR Output Register	—	0.81	—	0.97	—	1.17	ns
t <sub>SUDATA_EBR</sub>	Setup Data to EBR Memory	-0.26	—	-0.21	—	-0.17	—	ns
t <sub>HDATA_EBR</sub>	Hold Data to EBR Memory	0.41	—	0.49	—	0.59	—	ns
t <sub>SUADDR_EBR</sub>	Setup Address to EBR Memory	-0.26	—	-0.21	—	-0.17	—	ns
t <sub>HADDR_EBR</sub>	Hold Address to EBR Memory	0.41	—	0.49	—	0.59	—	ns
t <sub>SUWREN_EBR</sub>	Setup Write/Read Enable to EBR Memory	-0.17	—	-0.13	—	-0.11	—	ns
t <sub>HWREN_EBR</sub>	Hold Write/Read Enable to EBR Memory	0.26	—	0.31	—	0.37	—	ns
t <sub>SUCE_EBR</sub>	Clock Enable Setup Time to EBR Output Register	0.19	—	0.23	—	0.28	—	ns
t <sub>HCE_EBR</sub>	Clock Enable Hold Time to EBR Output Register	-0.13	—	-0.10	—	-0.08	—	ns

**LatticeXP Internal Timing Parameters<sup>1</sup> (Continued)**

Over Recommended Operating Conditions

Parameter	Description	-5		-4		-3		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{RSTO\_EBR}$	Reset To Output Delay Time from EBR Output Register	—	1.61	—	1.94	—	2.32	ns
<b>PLL Parameters</b>								
$t_{RSTREC}$	Reset Recovery to Rising Clock	1.00	—	1.00	—	1.00	—	ns
$t_{RSTSU}$	Reset Signal Setup Time	1.00	—	1.00	—	1.00	—	ns

1. Internal parameters are characterized but not tested on every device.

Timing v.F0.11

Pin Information Summary<sup>1</sup> (Cont.)

Pin Type		XP10		XP15			XP20		
		256 fpBGA	388 fpBGA	256 fpBGA	388 fpBGA	484 fpBGA	256 fpBGA	388 fpBGA	484 fpBGA
Single Ended User I/O		188	244	188	268	300	188	268	340
Differential Pair User I/O <sup>2</sup>		76	104	76	112	128	76	112	144
Configuration	Dedicated	11	11	11	11	11	11	11	11
	Muxed	14	14	14	14	14	14	14	14
TAP		5	5	5	5	5	5	5	5
Dedicated (total without supplies)		6	6	6	6	6	6	6	6
V <sub>CC</sub>		8	14	8	14	28	8	14	28
V <sub>CCAUX</sub>		4	4	4	4	12	4	4	12
V <sub>CCPLL</sub>		2	2	2	2	2	2	2	2
V <sub>CCIO</sub>	Bank0	2	5	2	5	4	2	5	4
	Bank1	2	5	2	5	4	2	5	4
	Bank2	2	4	2	4	4	2	4	4
	Bank3	2	4	2	4	4	2	4	4
	Bank4	2	5	2	5	4	2	5	4
	Bank5	2	5	2	5	4	2	5	4
	Bank6	2	4	2	4	4	2	4	4
	Bank7	2	4	2	4	4	2	4	4
GND		24	50	24	50	56	24	50	56
GND <sub>PLL</sub>		2	2	2	2	2	2	2	2
NC		0	24	0	0	40	0	0	0
Single Ended/ Differential I/O per Bank <sup>2</sup>	Bank0	26/11	33/14	26/11	39/16	40/17	26/11	39/16	47/20
	Bank1	26/11	33/14	26/11	39/16	40/17	26/11	39/16	47/20
	Bank2	21/8	28/12	21/8	28/12	35/15	21/8	28/12	38/16
	Bank3	21/8	28/12	21/8	28/12	35/15	21/8	28/12	38/16
	Bank4	26/11	33/14	26/11	39/16	40/17	26/11	39/16	47/20
	Bank5	26/11	33/14	26/11	39/16	40/17	26/11	39/16	47/20
	Bank6	21/8	28/12	21/8	28/12	35/15	21/8	28/12	38/16
	Bank7	21/8	28/12	21/8	28/12	35/15	21/8	28/12	38/16
V <sub>CCJ</sub>		1	1	1	1	1	1	1	1

- During configuration the user-programmable I/Os are tri-stated with an internal pull-up resistor enabled. If any pin is not used (or not bonded to a package pin), it is also tri-stated with an internal pull-up resistor enabled after configuration.
- The differential I/O per bank includes both dedicated LVDS and emulated LVDS pin pairs. Please see the Logic Signal Connections table for more information.

**LFXP3 Logic Signal Connections: 100 TQFP (Cont.)**

Pin Number	Pin Function	Bank	Differential	Dual Function
88	PT14B	1	-	D7
89	PT13B	0	C	BUSY
90	GNDIO0	0	-	-
91	PT13A	0	T	CS1N
92	PT12B	0	C	PCLKC0_0
93	PT12A	0	T	PCLKT0_0
94	VCCIO0	0	-	-
95	PT9A	0	-	DOUT
96	PT8A	0	-	WRITEN
97	PT6A	0	-	DI
98	PT5A	0	-	CSN
99	GND	-	-	-
100	CFG0	0	-	-

1. Applies to LFXP "C" only.

2. Applies to LFXP "E" only.

3. Supports dedicated LVDS outputs.

**LFXP3 & LFXP6 Logic Signal Connections: 144 TQFP (Cont.)**

Pin Number	LFXP3				LFXP6			
	Pin Function	Bank	Differential	Dual Function	Pin Function	Bank	Differential	Dual Function
47	PB11A	5	T	DQS	PB14A	5	T	DQS
48	PB11B	5	C	-	PB14B	5	C	-
49	VCCIO5	5	-	-	VCCIO5	5	-	-
50	PB12A	5	T	-	PB15A	5	T	-
51	PB12B	5	C	-	PB15B	5	C	-
52	PB13A	5	T	-	PB16A	5	T	-
53	PB13B	5	C	-	PB16B	5	C	-
54	GND	-	-	-	GND	-	-	-
55	PB14A	4	T	-	PB17A	4	T	-
56	GNDIO4	4	-	-	GNDIO4	4	-	-
57	PB14B	4	C	-	PB17B	4	C	-
58	PB15A	4	T	PCLKT4_0	PB18A	4	T	PCLKT4_0
59	PB15B	4	C	PCLKC4_0	PB18B	4	C	PCLKC4_0
60	PB16A	4	T	-	PB19A	4	T	-
61	VCCIO4	4	-	-	VCCIO4	4	-	-
62	PB16B	4	C	-	PB19B	4	C	-
63	PB19A	4	T	DQS	PB22A	4	T	DQS
64	GNDIO4	4	-	-	GNDIO4	4	-	-
65	PB19B	4	C	VREF1_4	PB22B	4	C	VREF1_4
66	PB20A	4	T	-	PB23A	4	T	-
67	PB20B	4	C	-	PB23B	4	C	-
68	VCCIO4	4	-	-	VCCIO4	4	-	-
69	PB22A	4	-	-	PB25A	4	-	-
70	PB24A	4	T	VREF2_4	PB27A	4	T	VREF2_4
71	PB24B	4	C	-	PB27B	4	C	-
72	PB25A	4	-	-	PB28A	4	-	-
73	VCC	-	-	-	VCC	-	-	-
74	PR18B	3	C <sup>3</sup>	-	PR26B	3	C <sup>3</sup>	-
75	GNDIO3	3	-	-	GNDIO3	3	-	-
76	PR18A	3	T <sup>3</sup>	-	PR26A	3	T <sup>3</sup>	-
77	PR17B	3	C	-	PR25B	3	C	-
78	PR17A	3	T	-	PR25A	3	T	-
79	PR16B	3	C <sup>3</sup>	-	PR24B	3	C <sup>3</sup>	-
80	PR16A	3	T <sup>3</sup>	DQS	PR24A	3	T <sup>3</sup>	DQS
81	PR15B	3	-	VREF1_3	PR23B	3	-	VREF1_3
82	PR14A	3	-	VREF2_3	PR22A	3	-	VREF2_3
83	PR13B	3	C	-	PR21B	3	C <sup>3</sup>	-
84	PR13A	3	T	-	PR21A	3	T <sup>3</sup>	-
85	GND	-	-	-	GND	-	-	-
86	PR12A	3	-	-	PR20A	3	-	-
87	PR11B	3	C	-	PR19B	3	C <sup>3</sup>	-
88	VCCIO3	3	-	-	VCCIO3	3	-	-
89	PR11A	3	T	-	PR19A	3	T <sup>3</sup>	-
90	GNDP1	-	-	-	GNDP1	-	-	-
91	VCCP1	-	-	-	VCCP1	-	-	-
92	PR9B	2	C	PCLKC2_0	PR12B	2	C	PCLKC2_0

**LFXP3 & LFXP6 Logic Signal Connections: 208 PQFP (Cont.)**

Pin Number	LFXP3				LFXP6			
	Pin Function	Bank	Differential	Dual Function	Pin Function	Bank	Differential	Dual Function
139	PR7A	2	T <sup>3</sup>	DQS	PR7A	2	T <sup>3</sup>	DQS
140	VCCIO2	2	-	-	VCCIO2	2	-	-
141	PR6B	2	-	VREF1_2	PR6B	2	-	VREF1_2
142	PR5A	2	-	VREF2_2	PR5A	2	-	VREF2_2
143	GNDIO2	2	-	-	GNDIO2	2	-	-
144	PR4B	2	C <sup>3</sup>	-	PR4B	2	C <sup>3</sup>	-
145	PR4A	2	T <sup>3</sup>	-	PR4A	2	T <sup>3</sup>	-
146	PR3B	2	C	RUM0_PLLC_FB_A	PR3B	2	C	RUM0_PLLC_FB_A
147	PR3A	2	T	RUM0_PLLT_FB_A	PR3A	2	T	RUM0_PLLT_FB_A
148	PR2B	2	C <sup>3</sup>	-	PR2B	2	C <sup>3</sup>	-
149	VCCIO2	2	-	-	VCCIO2	2	-	-
150	PR2A	2	T <sup>3</sup>	-	PR2A	2	T <sup>3</sup>	-
151	VCC	-	-	-	VCC	-	-	-
152	VCCAUX	-	-	-	VCCAUX	-	-	-
153	TDO	-	-	-	TDO	-	-	-
154	VCCJ	-	-	-	VCCJ	-	-	-
155	TDI	-	-	-	TDI	-	-	-
156	TMS	-	-	-	TMS	-	-	-
157	TCK	-	-	-	TCK	-	-	-
158	VCC	-	-	-	VCC	-	-	-
159	PT25A	1	-	VREF1_1	PT28A	1	-	VREF1_1
160	PT24B	1	C	-	PT27B	1	C	-
161	PT24A	1	T	-	PT27A	1	T	-
162	PT23A	1	-	D0	PT26A	1	-	D0
163	GNDIO1	1	-	-	GNDIO1	1	-	-
164	PT22B	1	C	D1	PT25B	1	C	D1
165	PT22A	1	T	VREF2_1	PT25A	1	T	VREF2_1
166	PT21A	1	-	D2	PT24A	1	-	D2
167	VCCIO1	1	-	-	VCCIO1	1	-	-
168	PT20B	1	C	D3	PT23B	1	C	D3
169	PT20A	1	T	-	PT23A	1	T	-
170	PT19B	1	C	-	PT22B	1	C	-
171	PT19A	1	T	DQS	PT22A	1	T	DQS
172	GNDIO1	1	-	-	GNDIO1	1	-	-
173	PT18B	1	-	-	PT21B	1	-	-
174	PT17A	1	-	D4	PT20A	1	-	D4
175	PT16B	1	C	-	PT19B	1	C	-
176	PT16A	1	T	D5	PT19A	1	T	D5
177	VCCIO1	1	-	-	VCCIO1	1	-	-
178	PT15B	1	C	D6	PT18B	1	C	D6
179	PT15A	1	T	-	PT18A	1	T	-
180	PT14B	1	-	D7	PT17B	1	-	D7
181	GND	-	-	-	GND	-	-	-
182	VCC	-	-	-	VCC	-	-	-
183	PT13B	0	C	BUSY	PT16B	0	C	BUSY
184	GNDIO0	0	-	-	GNDIO0	0	-	-

**LFXP15 & LFXP20 Logic Signal Connections: 256 fpBGA**

Ball Number	LFXP15					LFXP20				
	Ball Function	Bank	Differential	Dual Function		Ball Function	Bank	Differential	Dual Function	
C2	PROGRAMN	7	-	-		PROGRAMN	7	-	-	
C1	CCLK	7	-	-		CCLK	7	-	-	
-	GNDIO7	7	-	-		GNDIO7	7	-	-	
-	GNDIO7	7	-	-		GNDIO7	7	-	-	
D2	PL7A	7	T	LUM0_PLLT_FB_A		PL7A	7	T	LUM0_PLLT_FB_A	
D3	PL7B	7	C	LUM0_PLLC_FB_A		PL7B	7	C	LUM0_PLLC_FB_A	
D1	PL9A	7	-	-		PL9A	7	-	-	
E2	PL10B	7	-	VREF1_7		PL10B	7	-	VREF1_7	
E1	PL11A	7	T <sup>3</sup>	DQS		PL11A	7	T <sup>3</sup>	DQS	
F1	PL11B	7	C <sup>3</sup>	-		PL11B	7	C <sup>3</sup>	-	
-	GNDIO7	7	-	-		GNDIO7	7	-	-	
E3	PL12A	7	T	-		PL12A	7	T	-	
F4	PL12B	7	C	-		PL12B	7	C	-	
F3	PL13A	7	T <sup>3</sup>	-		PL13A	7	T <sup>3</sup>	-	
F2	PL13B	7	C <sup>3</sup>	-		PL13B	7	C <sup>3</sup>	-	
G1	PL15B	7	-	-		PL15B	7	-	-	
-	GNDIO7	7	-	-		GNDIO7	7	-	-	
G3	PL16A	7	T	LUM0_PLLT_IN_A		PL16A	7	T	LUM0_PLLT_IN_A	
G2	PL16B	7	C	LUM0_PLLC_IN_A		PL16B	7	C	LUM0_PLLC_IN_A	
H1	PL17A	7	T <sup>3</sup>	-		PL17A	7	T <sup>3</sup>	-	
H2	PL17B	7	C <sup>3</sup>	-		PL17B	7	C <sup>3</sup>	-	
G4	PL18A	7	-	VREF2_7		PL18A	7	-	VREF2_7	
G5	PL19B	7	-	-		PL19B	7	-	-	
J1	PL20A	7	T <sup>3</sup>	DQS		PL20A	7	T <sup>3</sup>	DQS	
-	GNDIO7	7	-	-		GNDIO7	7	-	-	
J2	PL20B	7	C <sup>3</sup>	-		PL20B	7	C <sup>3</sup>	-	
H3	PL22A	7	T <sup>3</sup>	-		PL22A	7	T <sup>3</sup>	-	
J3	PL22B	7	C <sup>3</sup>	-		PL22B	7	C <sup>3</sup>	-	
H4	VCCP0	-	-	-		VCCP0	-	-	-	
H5	GNDP0	-	-	-		GNDP0	-	-	-	
K1	PL24A	6	T	PCLKT6_0		PL28A	6	T	PCLKT6_0	
-	GNDIO6	6	-	-		GNDIO6	6	-	-	
K2	PL24B	6	C	PCLKC6_0		PL28B	6	C	PCLKC6_0	
J4	PL26A	6	-	-		PL30A	6	-	-	
J5	PL27B	6	-	VREF1_6		PL31B	6	-	VREF1_6	
L1	PL28A	6	T <sup>3</sup>	DQS		PL32A	6	T <sup>3</sup>	DQS	
L2	PL28B	6	C <sup>3</sup>	-		PL32B	6	C <sup>3</sup>	-	
-	GNDIO6	6	-	-		GNDIO6	6	-	-	
M1	PL29A	6	T	LLM0_PLLT_IN_A		PL33A	6	T	LLM0_PLLT_IN_A	
M2	PL29B	6	C	LLM0_PLLC_IN_A		PL33B	6	C	LLM0_PLLC_IN_A	
K3	PL30A	6	T <sup>3</sup>	-		PL34A	6	T <sup>3</sup>	-	
L3	PL30B	6	C <sup>3</sup>	-		PL34B	6	C <sup>3</sup>	-	

**LFXP10, LFXP15 & LFXP20 Logic Signal Connections: 388 fpBGA (Cont.)**

Ball Number	LFXP10				LFXP15				LFXP20			
	Ball Function	Bank	Diff.	Dual Function	Ball Function	Bank	Diff.	Dual Function	Ball Function	Bank	Diff.	Dual Function
Y10	PB11B	5	C	-	PB16B	5	C	-	PB20B	5	C	-
AA7	PB12A	5	T	-	PB17A	5	T	-	PB21A	5	T	-
AB7	PB12B	5	C	VREF2_5	PB17B	5	C	VREF2_5	PB21B	5	C	VREF2_5
Y7	PB13A	5	T	-	PB18A	5	T	-	PB22A	5	T	-
-	GNDIO5	5	-	-	GNDIO5	5	-	-	GNDIO5	5	-	-
AA8	PB13B	5	C	-	PB18B	5	C	-	PB22B	5	C	-
AB8	PB14A	5	T	-	PB19A	5	T	-	PB23A	5	T	-
Y8	PB14B	5	C	-	PB19B	5	C	-	PB23B	5	C	-
AB9	PB15A	5	T	-	PB20A	5	T	-	PB24A	5	T	-
AA9	PB15B	5	C	-	PB20B	5	C	-	PB24B	5	C	-
W10	PB16A	5	-	-	PB21A	5	-	-	PB25A	5	-	-
W11	PB17B	5	-	-	PB22B	5	-	-	PB26B	5	-	-
AB10	PB18A	5	T	DQS	PB23A	5	T	DQS	PB27A	5	T	DQS
AA10	PB18B	5	C	-	PB23B	5	C	-	PB27B	5	C	-
-	GNDIO5	5	-	-	GNDIO5	5	-	-	GNDIO5	5	-	-
AA11	PB19A	5	T	-	PB24A	5	T	-	PB28A	5	T	-
AB11	PB19B	5	C	-	PB24B	5	C	-	PB28B	5	C	-
Y11	PB20A	5	T	-	PB25A	5	T	-	PB29A	5	T	-
Y12	PB20B	5	C	-	PB25B	5	C	-	PB29B	5	C	-
AB12	PB21A	4	T	-	PB26A	4	T	-	PB30A	4	T	-
AA12	PB21B	4	C	-	PB26B	4	C	-	PB30B	4	C	-
AB13	PB22A	4	T	PCLKT4_0	PB27A	4	T	PCLKT4_0	PB31A	4	T	PCLKT4_0
AA13	PB22B	4	C	PCLKC4_0	PB27B	4	C	PCLKC4_0	PB31B	4	C	PCLKC4_0
-	GNDIO4	4	-	-	GNDIO4	4	-	-	GNDIO4	4	-	-
AA14	PB23A	4	T	-	PB28A	4	T	-	PB32A	4	T	-
AB14	PB23B	4	C	-	PB28B	4	C	-	PB32B	4	C	-
W12	PB24A	4	-	-	PB29A	4	-	-	PB33A	4	-	-
W13	PB25B	4	-	-	PB30B	4	-	-	PB34B	4	-	-
AA15	PB26A	4	T	DQS	PB31A	4	T	DQS	PB35A	4	T	DQS
AB15	PB26B	4	C	VREF1_4	PB31B	4	C	VREF1_4	PB35B	4	C	VREF1_4
AA16	PB27A	4	T	-	PB32A	4	T	-	PB36A	4	T	-
AB16	PB27B	4	C	-	PB32B	4	C	-	PB36B	4	C	-
Y17	PB28A	4	T	-	PB33A	4	T	-	PB37A	4	T	-
-	GNDIO4	4	-	-	GNDIO4	4	-	-	GNDIO4	4	-	-
AA17	PB28B	4	C	-	PB33B	4	C	-	PB37B	4	C	-
Y13	PB29A	4	T	-	PB34A	4	T	-	PB38A	4	T	-
Y14	PB29B	4	C	-	PB34B	4	C	-	PB38B	4	C	-
AB17	PB30A	4	T	-	PB35A	4	T	-	PB39A	4	T	-
Y18	PB30B	4	C	-	PB35B	4	C	-	PB39B	4	C	-
AA18	PB31A	4	T	VREF2_4	PB36A	4	T	VREF2_4	PB40A	4	T	VREF2_4
AB18	PB31B	4	C	-	PB36B	4	C	-	PB40B	4	C	-
Y19	PB32A	4	-	-	PB37A	4	-	-	PB41A	4	-	-
AB19	PB33B	4	-	-	PB38B	4	-	-	PB42B	4	-	-
-	GNDIO4	4	-	-	GNDIO4	4	-	-	GNDIO4	4	-	-
AA19	PB34A	4	T	DQS	PB39A	4	T	DQS	PB43A	4	T	DQS
Y20	PB34B	4	C	-	PB39B	4	C	-	PB43B	4	C	-
W14	PB35A	4	T	-	PB40A	4	T	-	PB44A	4	T	-
W15	PB35B	4	C	-	PB40B	4	C	-	PB44B	4	C	-
AB20	PB36A	4	T	-	PB41A	4	T	-	PB45A	4	T	-

**LFXP10, LFXP15 & LFXP20 Logic Signal Connections: 388 fpBGA (Cont.)**

Ball Number	LFXP10				LFXP15				LFXP20			
	Ball Function	Bank	Diff.	Dual Function	Ball Function	Bank	Diff.	Dual Function	Ball Function	Bank	Diff.	Dual Function
M21	VCCP1	-	-	-	VCCP1	-	-	-	VCCP1	-	-	-
-	GNDIO2	2	-	-	GNDIO2	2	-	-	GNDIO2	2	-	-
M22	PR18B	2	C <sup>3</sup>	-	PR22B	2	C <sup>3</sup>	-	PR22B	2	C <sup>3</sup>	-
L22	PR18A	2	T <sup>3</sup>	-	PR22A	2	T <sup>3</sup>	-	PR22A	2	T <sup>3</sup>	-
K22	PR17B	2	C	PCLKC2_0	PR21B	2	C	PCLKC2_0	PR21B	2	C	PCLKC2_0
K21	PR17A	2	T	PCLKT2_0	PR21A	2	T	PCLKT2_0	PR21A	2	T	PCLKT2_0
L19	PR16B	2	C <sup>3</sup>	-	PR20B	2	C <sup>3</sup>	-	PR20B	2	C <sup>3</sup>	-
K20	PR16A	2	T <sup>3</sup>	DQS	PR20A	2	T <sup>3</sup>	DQS	PR20A	2	T <sup>3</sup>	DQS
L20	PR15B	2	-	-	PR19B	2	-	-	PR19B	2	-	-
L21	PR14A	2	-	VREF1_2	PR18A	2	-	VREF1_2	PR18A	2	-	VREF1_2
-	GNDIO2	2	-	-	GNDIO2	2	-	-	GNDIO2	2	-	-
J22	PR13B	2	C <sup>3</sup>	-	PR17B	2	C <sup>3</sup>	-	PR17B	2	C <sup>3</sup>	-
J21	PR13A	2	T <sup>3</sup>	-	PR17A	2	T <sup>3</sup>	-	PR17A	2	T <sup>3</sup>	-
H22	PR12B	2	C	RUM0_PLLC_IN_A	PR16B	2	C	RUM0_PLLC_IN_A	PR16B	2	C	RUM0_PLLC_IN_A
H21	PR12A	2	T	RUM0_PLLT_IN_A	PR16A	2	T	RUM0_PLLT_IN_A	PR16A	2	T	RUM0_PLLT_IN_A
K19	PR11B	2	C <sup>3</sup>	-	PR15B	2	C <sup>3</sup>	-	PR15B	2	C <sup>3</sup>	-
J19	PR11A	2	T <sup>3</sup>	-	PR15A	2	T <sup>3</sup>	-	PR15A	2	T <sup>3</sup>	-
-	GNDIO2	2	-	-	GNDIO2	2	-	-	GNDIO2	2	-	-
J20	PR9B	2	C <sup>3</sup>	-	PR13B	2	C <sup>3</sup>	-	PR13B	2	C <sup>3</sup>	-
H20	PR9A	2	T <sup>3</sup>	-	PR13A	2	T <sup>3</sup>	-	PR13A	2	T <sup>3</sup>	-
H19	PR8B	2	C	-	PR12B	2	C	-	PR12B	2	C	-
G19	PR8A	2	T	-	PR12A	2	T	-	PR12A	2	T	-
G22	PR7B	2	C <sup>3</sup>	-	PR11B	2	C <sup>3</sup>	-	PR11B	2	C <sup>3</sup>	-
G21	PR7A	2	T <sup>3</sup>	DQS	PR11A	2	T <sup>3</sup>	DQS	PR11A	2	T <sup>3</sup>	DQS
-	GNDIO2	2	-	-	GNDIO2	2	-	-	GNDIO2	2	-	-
F20	PR6B	2	-	-	PR10B	2	-	-	PR10B	2	-	-
G20	PR5A	2	-	VREF2_2	PR9A	2	-	VREF2_2	PR9A	2	-	VREF2_2
F22	PR4B	2	C <sup>3</sup>	-	PR8B	2	C <sup>3</sup>	-	PR8B	2	C <sup>3</sup>	-
F21	PR4A	2	T <sup>3</sup>	-	PR8A	2	T <sup>3</sup>	-	PR8A	2	T <sup>3</sup>	-
E22	PR3B	2	C	RUM0_PLLC_FB_A	PR7B	2	C	RUM0_PLLC_FB_A	PR7B	2	C	RUM0_PLLC_FB_A
E21	PR3A	2	T	RUM0_PLLT_FB_A	PR7A	2	T	RUM0_PLLT_FB_A	PR7A	2	T	RUM0_PLLT_FB_A
D22	PR2B	2	C <sup>3</sup>	-	PR6B	2	C <sup>3</sup>	-	PR6B	2	C <sup>3</sup>	-
D21	PR2A	2	T <sup>3</sup>	-	PR6A	2	T <sup>3</sup>	-	PR6A	2	T <sup>3</sup>	-
-	GNDIO2	2	-	-	GNDIO2	2	-	-	GNDIO2	2	-	-
F19	TDO	-	-	-	TDO	-	-	-	TDO	-	-	-
E20	VCCJ	-	-	-	VCCJ	-	-	-	VCCJ	-	-	-
D20	TDI	-	-	-	TDI	-	-	-	TDI	-	-	-
D19	TMS	-	-	-	TMS	-	-	-	TMS	-	-	-
D18	TCK	-	-	-	TCK	-	-	-	TCK	-	-	-
-	GNDIO1	1	-	-	GNDIO1	1	-	-	GNDIO1	1	-	-
E19	-	-	-	-	PT48A	1	-	-	PT52A	1	-	-
D17	-	-	-	-	PT47B	1	C	-	PT51B	1	C	-
D16	-	-	-	-	PT47A	1	T	DQS	PT51A	1	T	DQS
C16	-	-	-	-	PT46B	1	-	-	PT50B	1	-	-
C15	-	-	-	-	PT45A	1	-	-	PT49A	1	-	-
C17	-	-	-	-	PT44B	1	C	-	PT48B	1	C	-
C18	PT39A	1	-	-	PT44A	1	T	-	PT48A	1	T	-
C19	PT38B	1	C	-	PT43B	1	C	-	PT47B	1	C	-
-	GNDIO1	1	-	-	GNDIO1	1	-	-	GNDIO1	1	-	-

**LFXP15 & LFXP20 Logic Signal Connections: 484 fpBGA (Cont.)**

Ball Number	LFXP15				LFXP20			
	Ball Function	Bank	Differential	Dual Function	Ball Function	Bank	Differential	Dual Function
AB5	PB16A	5	T	-	PB20A	5	T	-
AB6	PB16B	5	C	-	PB20B	5	C	-
AA8	PB17A	5	T	-	PB21A	5	T	-
AA9	PB17B	5	C	VREF2_5	PB21B	5	C	VREF2_5
W10	PB18A	5	T	-	PB22A	5	T	-
-	GNDIO5	5	-	-	GNDIO5	5	-	-
V10	PB18B	5	C	-	PB22B	5	C	-
AB7	PB19A	5	T	-	PB23A	5	T	-
AB8	PB19B	5	C	-	PB23B	5	C	-
AB9	PB20A	5	T	-	PB24A	5	T	-
AB10	PB20B	5	C	-	PB24B	5	C	-
Y10	PB21A	5	-	-	PB25A	5	-	-
AA10	PB22B	5	-	-	PB26B	5	-	-
W11	PB23A	5	T	DQS	PB27A	5	T	DQS
V11	PB23B	5	C	-	PB27B	5	C	-
-	GNDIO5	5	-	-	GNDIO5	5	-	-
Y11	PB24A	5	T	-	PB28A	5	T	-
AA11	PB24B	5	C	-	PB28B	5	C	-
AB11	PB25A	5	T	-	PB29A	5	T	-
AB12	PB25B	5	C	-	PB29B	5	C	-
Y12	PB26A	4	T	-	PB30A	4	T	-
AA12	PB26B	4	C	-	PB30B	4	C	-
W12	PB27A	4	T	PCLKT4_0	PB31A	4	T	PCLKT4_0
V12	PB27B	4	C	PCLKC4_0	PB31B	4	C	PCLKC4_0
-	GNDIO4	4	-	-	GNDIO4	4	-	-
AB13	PB28A	4	T	-	PB32A	4	T	-
AB14	PB28B	4	C	-	PB32B	4	C	-
AA13	PB29A	4	-	-	PB33A	4	-	-
Y13	PB30B	4	-	-	PB34B	4	-	-
AB15	PB31A	4	T	DQS	PB35A	4	T	DQS
AB16	PB31B	4	C	VREF1_4	PB35B	4	C	VREF1_4
V13	PB32A	4	T	-	PB36A	4	T	-
W13	PB32B	4	C	-	PB36B	4	C	-
AA14	PB33A	4	T	-	PB37A	4	T	-
-	GNDIO4	4	-	-	GNDIO4	4	-	-
AA15	PB33B	4	C	-	PB37B	4	C	-
AB17	PB34A	4	T	-	PB38A	4	T	-
AB18	PB34B	4	C	-	PB38B	4	C	-
W14	PB35A	4	T	-	PB39A	4	T	-
Y14	PB35B	4	C	-	PB39B	4	C	-
U14	PB36A	4	T	VREF2_4	PB40A	4	T	VREF2_4
V14	PB36B	4	C	-	PB40B	4	C	-

**LFXP15 & LFXP20 Logic Signal Connections: 484 fpBGA (Cont.)**

Ball Number	LFXP15				LFXP20			
	Ball Function	Bank	Differential	Dual Function	Ball Function	Bank	Differential	Dual Function
H13	VCCIO1	1	-	-	VCCIO1	1	-	-
K15	VCCIO2	2	-	-	VCCIO2	2	-	-
L15	VCCIO2	2	-	-	VCCIO2	2	-	-
L16	VCCIO2	2	-	-	VCCIO2	2	-	-
L17	VCCIO2	2	-	-	VCCIO2	2	-	-
M15	VCCIO3	3	-	-	VCCIO3	3	-	-
M16	VCCIO3	3	-	-	VCCIO3	3	-	-
M17	VCCIO3	3	-	-	VCCIO3	3	-	-
N15	VCCIO3	3	-	-	VCCIO3	3	-	-
R12	VCCIO4	4	-	-	VCCIO4	4	-	-
R13	VCCIO4	4	-	-	VCCIO4	4	-	-
T12	VCCIO4	4	-	-	VCCIO4	4	-	-
U12	VCCIO4	4	-	-	VCCIO4	4	-	-
R10	VCCIO5	5	-	-	VCCIO5	5	-	-
R11	VCCIO5	5	-	-	VCCIO5	5	-	-
T11	VCCIO5	5	-	-	VCCIO5	5	-	-
U11	VCCIO5	5	-	-	VCCIO5	5	-	-
M6	VCCIO6	6	-	-	VCCIO6	6	-	-
M7	VCCIO6	6	-	-	VCCIO6	6	-	-
M8	VCCIO6	6	-	-	VCCIO6	6	-	-
N8	VCCIO6	6	-	-	VCCIO6	6	-	-
K8	VCCIO7	7	-	-	VCCIO7	7	-	-
L6	VCCIO7	7	-	-	VCCIO7	7	-	-
L7	VCCIO7	7	-	-	VCCIO7	7	-	-
L8	VCCIO7	7	-	-	VCCIO7	7	-	-

1. Applies to LFXP "C" only.
2. Applies to LFXP "E" only.
3. Supports dedicated LVDS outputs.

**Conventional Packaging****Commercial**

<b>Part Number</b>	<b>I/Os</b>	<b>Voltage</b>	<b>Grade</b>	<b>Package</b>	<b>Pins</b>	<b>Temp.</b>	<b>LUTs</b>
LFXP3C-3Q208C	136	1.8/2.5/3.3V	-3	PQFP	208	COM	3.1K
LFXP3C-4Q208C	136	1.8/2.5/3.3V	-4	PQFP	208	COM	3.1K
LFXP3C-5Q208C	136	1.8/2.5/3.3V	-5	PQFP	208	COM	3.1K
LFXP3C-3T144C	100	1.8/2.5/3.3V	-3	TQFP	144	COM	3.1K
LFXP3C-4T144C	100	1.8/2.5/3.3V	-4	TQFP	144	COM	3.1K
LFXP3C-5T144C	100	1.8/2.5/3.3V	-5	TQFP	144	COM	3.1K
LFXP3C-3T100C	62	1.8/2.5/3.3V	-3	TQFP	100	COM	3.1K
LFXP3C-4T100C	62	1.8/2.5/3.3V	-4	TQFP	100	COM	3.1K
LFXP3C-5T100C	62	1.8/2.5/3.3V	-5	TQFP	100	COM	3.1K

<b>Part Number</b>	<b>I/Os</b>	<b>Voltage</b>	<b>Grade</b>	<b>Package</b>	<b>Pins</b>	<b>Temp.</b>	<b>LUTs</b>
LFXP6C-3F256C	188	1.8/2.5/3.3V	-3	fpBGA	256	COM	5.8K
LFXP6C-4F256C	188	1.8/2.5/3.3V	-4	fpBGA	256	COM	5.8K
LFXP6C-5F256C	188	1.8/2.5/3.3V	-5	fpBGA	256	COM	5.8K
LFXP6C-3Q208C	142	1.8/2.5/3.3V	-3	PQFP	208	COM	5.8K
LFXP6C-4Q208C	142	1.8/2.5/3.3V	-4	PQFP	208	COM	5.8K
LFXP6C-5Q208C	142	1.8/2.5/3.3V	-5	PQFP	208	COM	5.8K
LFXP6C-3T144C	100	1.8/2.5/3.3V	-3	TQFP	144	COM	5.8K
LFXP6C-4T144C	100	1.8/2.5/3.3V	-4	TQFP	144	COM	5.8K
LFXP6C-5T144C	100	1.8/2.5/3.3V	-5	TQFP	144	COM	5.8K

<b>Part Number</b>	<b>I/Os</b>	<b>Voltage</b>	<b>Grade</b>	<b>Package</b>	<b>Pins</b>	<b>Temp.</b>	<b>LUTs</b>
LFXP10C-3F388C	244	1.8/2.5/3.3V	-3	fpBGA	388	COM	9.7K
LFXP10C-4F388C	244	1.8/2.5/3.3V	-4	fpBGA	388	COM	9.7K
LFXP10C-5F388C	244	1.8/2.5/3.3V	-5	fpBGA	388	COM	9.7K
LFXP10C-3F256C	188	1.8/2.5/3.3V	-3	fpBGA	256	COM	9.7K
LFXP10C-4F256C	188	1.8/2.5/3.3V	-4	fpBGA	256	COM	9.7K
LFXP10C-5F256C	188	1.8/2.5/3.3V	-5	fpBGA	256	COM	9.7K

## Commercial (Cont.)

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs
LFXP6E-3F256C	188	1.2V	-3	fpBGA	256	COM	5.8K
LFXP6E-4F256C	188	1.2V	-4	fpBGA	256	COM	5.8K
LFXP6E-5F256C	188	1.2V	-5	fpBGA	256	COM	5.8K
LFXP6E-3Q208C	142	1.2V	-3	PQFP	208	COM	5.8K
LFXP6E-4Q208C	142	1.2V	-4	PQFP	208	COM	5.8K
LFXP6E-5Q208C	142	1.2V	-5	PQFP	208	COM	5.8K
LFXP6E-3T144C	100	1.2V	-3	TQFP	144	COM	5.8K
LFXP6E-4T144C	100	1.2V	-4	TQFP	144	COM	5.8K
LFXP6E-5T144C	100	1.2V	-5	TQFP	144	COM	5.8K

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs
LFXP10E-3F388C	244	1.2V	-3	fpBGA	388	COM	9.7K
LFXP10E-4F388C	244	1.2V	-4	fpBGA	388	COM	9.7K
LFXP10E-5F388C	244	1.2V	-5	fpBGA	388	COM	9.7K
LFXP10E-3F256C	188	1.2V	-3	fpBGA	256	COM	9.7K
LFXP10E-4F256C	188	1.2V	-4	fpBGA	256	COM	9.7K
LFXP10E-5F256C	188	1.2V	-5	fpBGA	256	COM	9.7K

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs
LFXP15E-3F484C	300	1.2V	-3	fpBGA	484	COM	15.5K
LFXP15E-4F484C	300	1.2V	-4	fpBGA	484	COM	15.5K
LFXP15E-5F484C	300	1.2V	-5	fpBGA	484	COM	15.5K
LFXP15E-3F388C	268	1.2V	-3	fpBGA	388	COM	15.5K
LFXP15E-4F388C	268	1.2V	-4	fpBGA	388	COM	15.5K
LFXP15E-5F388C	268	1.2V	-5	fpBGA	388	COM	15.5K
LFXP15E-3F256C	188	1.2V	-3	fpBGA	256	COM	15.5K
LFXP15E-4F256C	188	1.2V	-4	fpBGA	256	COM	15.5K
LFXP15E-5F256C	188	1.2V	-5	fpBGA	256	COM	15.5K

**Commercial (Cont.)**

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs
LFXP15E-3FN484C	300	1.2V	-3	fpBGA	484	COM	15.5K
LFXP15E-4FN484C	300	1.2V	-4	fpBGA	484	COM	15.5K
LFXP15E-5FN484C	300	1.2V	-5	fpBGA	484	COM	15.5K
LFXP15E-3FN388C	268	1.2V	-3	fpBGA	388	COM	15.5K
LFXP15E-4FN388C	268	1.2V	-4	fpBGA	388	COM	15.5K
LFXP15E-5FN388C	268	1.2V	-5	fpBGA	388	COM	15.5K
LFXP15E-3FN256C	188	1.2V	-3	fpBGA	256	COM	15.5K
LFXP15E-4FN256C	188	1.2V	-4	fpBGA	256	COM	15.5K
LFXP15E-5FN256C	188	1.2V	-5	fpBGA	256	COM	15.5K

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs
LFXP20E-3FN484C	340	1.2V	-3	fpBGA	484	COM	19.7K
LFXP20E-4FN484C	340	1.2V	-4	fpBGA	484	COM	19.7K
LFXP20E-5FN484C	340	1.2V	-5	fpBGA	484	COM	19.7K
LFXP20E-3FN388C	268	1.2V	-3	fpBGA	388	COM	19.7K
LFXP20E-4FN388C	268	1.2V	-4	fpBGA	388	COM	19.7K
LFXP20E-5FN388C	268	1.2V	-5	fpBGA	388	COM	19.7K
LFXP20E-3FN256C	188	1.2V	-3	fpBGA	256	COM	19.7K
LFXP20E-4FN256C	188	1.2V	-4	fpBGA	256	COM	19.7K
LFXP20E-5FN256C	188	1.2V	-5	fpBGA	256	COM	19.7K

**Industrial**

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs
LFXP3C-3QN208I	136	1.8/2.5/3.3V	-3	PQFP	208	IND	3.1K
LFXP3C-4QN208I	136	1.8/2.5/3.3V	-4	PQFP	208	IND	3.1K
LFXP3C-3TN144I	100	1.8/2.5/3.3V	-3	TQFP	144	IND	3.1K
LFXP3C-4TN144I	100	1.8/2.5/3.3V	-4	TQFP	144	IND	3.1K
LFXP3C-3TN100I	62	1.8/2.5/3.3V	-3	TQFP	100	IND	3.1K
LFXP3C-4TN100I	62	1.8/2.5/3.3V	-4	TQFP	100	IND	3.1K

Part Number	I/Os	Voltage	Grade	Package	Pins	Temp.	LUTs
LFXP6C-3FN256I	188	1.8/2.5/3.3V	-3	fpBGA	256	IND	5.8K
LFXP6C-4FN256I	188	1.8/2.5/3.3V	-4	fpBGA	256	IND	5.8K
LFXP6C-3QN208I	142	1.8/2.5/3.3V	-3	PQFP	208	IND	5.8K
LFXP6C-4QN208I	142	1.8/2.5/3.3V	-4	PQFP	208	IND	5.8K
LFXP6C-3TN144I	100	1.8/2.5/3.3V	-3	TQFP	144	IND	5.8K
LFXP6C-4TN144I	100	1.8/2.5/3.3V	-4	TQFP	144	IND	5.8K